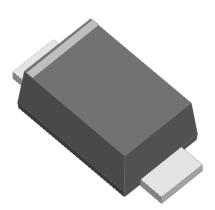




Surface Mount Schottky Rectifier





Features

- •Low profile package
- Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

Typical Applications

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

Mechanical Date

- Package: SOD-323FL
 Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- Terminals: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- Polarity: Cathode line denotes the cathode end

■Maximum Ratings (Tj=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	FM14
Device marking code			FM14
Repetitive peak reverse voltage	VRRM	V	40
Average rectified output current @60Hz sine wave, Resistance load, TC (FIG.1)	IO	А	1.0
Surge(non-repetitive)forward current @ 60Hz half-sine wave,1 cycle, Tj=25°C	IFOM	А	30
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C	IFSM		60
Current squared time @1ms≤t≤8.3ms Tj =25°C,Rating of per diode	I2t	A2S	3.74
Typical junction capacitance @Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	Cj	pF	43
Storage temperature	T _{stg}	°C	-55 ~+125
Junction temperature	Tj	°C	-55 ~+125





■Electrical Characteristics (Tj=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	Min	Тур	Max
Peak Forward Voltage V _{FM} V	V	I _{FM} =1.0A Tj=25°C	-	0.48	0.55	
	V	I _{FM} =1.0A Tj=100°C	-	-	0.50	
Maximum DC reverse current at rated DC blocking voltage	I _{RRM1}	mA	V _{RM} =V _{RRM} Tj=25°C	-	-	0.5
per diode	I _{RRM2}		V _{RM} =V _{RRM} Tj=100°C	-	•	10

Note1:Pulse test:300uS pulse widh,1% duty cycle

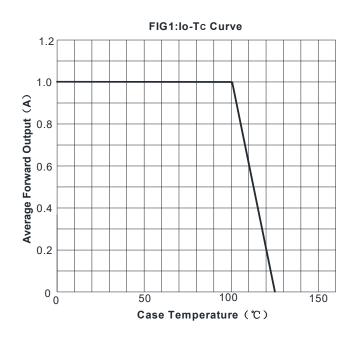
Note2:Pulse test:pulse widh 40mS

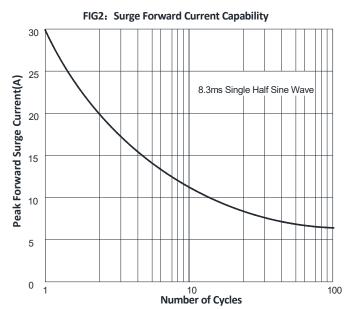
$\blacksquare \underline{\textbf{Thermal Characteristics}} \quad (\mathsf{T}_j\text{=}25^\circ C \; \mathsf{Unless \; otherwise \; specified})$

PARAMETER	SYMBOL	UNIT	FM14
RθJ-A Thermal Resistance RθJ-c	RøJ-A	9600	901)
	°C/W	46 ¹⁾	

Note:

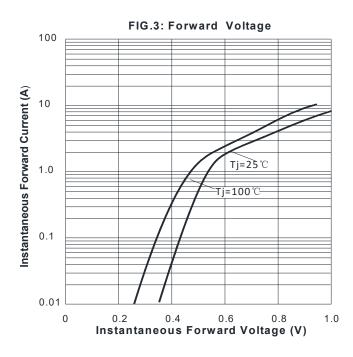
■ Characteristics(Typical)

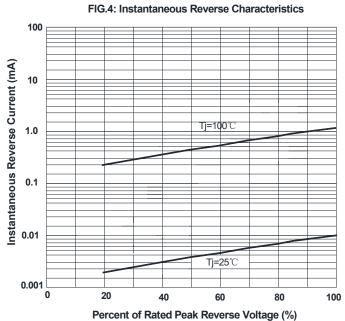




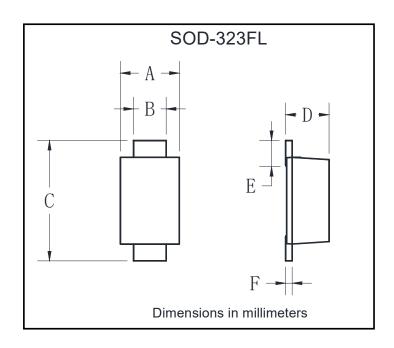
⁽¹⁾ Thermal resistance between junction and ambient and between junction and lead mounted on P.C.B with 3mm*3mm copper pad areas.







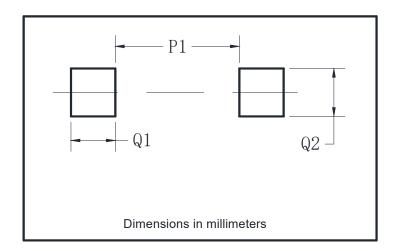
■ Outline Dimensions



SOD-323FL				
Dim	Min	Max		
Α	1.05	1.45		
В	0.90	1.15		
С	2.30	2.70		
D	0.80	1.20		
E	0.25	0.70		
F	0.05	0.25		



■ Suggested pad layout



SOD-323FL		
Dim	Millimeters	
P1	1.30	
Q1	1.00	
Q2	1.50	



FM14

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